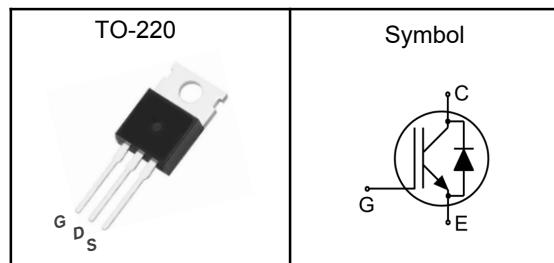


600V/30A Field Stop Trench IGBT

Features

- Trench FS II Technology
- Very low VCE(sat)
- High speed switching
- ROHS Compliant

Pin Description



Applications

- Inverter welding machine
- Motor drives
- UPS

V_{CES}	600	V
$V_{CE(sat)-Typ}$	1.7	V
I_c	30	A

Absolute Maximum Ratings ($T_c=25^\circ\text{C}$, Unless Otherwise Noted)

Parameter	Symbol	Rating	Units
Collector-Emitter Voltage	V_{CES}	600	V
Gate- Emitter Voltage	V_{GES}	± 30	V
Collector Current ¹	I_c	60	A
Collector Current ¹	I_c	30	A
Pulsed Collector Current ²	I_{CM}	90	A
Diode Continuous Forward Current	I_F	60	A
Diode Continuous Forward Current	I_F	30	A
Diode Pulsed Forward Current	I_{FM}	90	A
Power Dissipation	P_D	230	W
Power Dissipation	P_D	115	W
Storage Temperature Range	T_{STG}	-55 to 175	°C
Operating Junction Temperature Range	T_J	-55 to 175	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction-Ambient	$R_{\theta JA}$	---	40	°C/W
Thermal Resistance Junction to case for IGBT	$R_{\theta JC}$	---	0.65	°C/W
Thermal Resistance Junction to case for Diode	$R_{\theta JCD}$	---	0.79	°C/W

600V/30A Field Stop Trench IGBT

Electrical Characteristics ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-Emitter Breakdown Voltage	$V_{(\text{BR})\text{CES}}$	$V_{\text{GE}}=0\text{V}, I_D=1\text{mA}$	600	---	---	V
Collector-Emitter Saturation Voltage	$V_{\text{CE}(\text{sat})}$	$V_{\text{GE}}=15\text{V}, I_C=30\text{A}, T_J=25^\circ\text{C}$	---	1.7	2.0	V
		$V_{\text{GE}}=15\text{V}, I_C=30\text{A}, T_J=150^\circ\text{C}$	---	1.9	---	V
Gate Threshold Voltage	$V_{\text{GE}(\text{th})}$	$V_{\text{CE}}=V_{\text{GE}}, I_C=1\text{mA}$	4	5.5	6.5	V
Collector-Emitter Leakage Current	I_{CES}	$V_{\text{CE}}=600\text{V}, V_{\text{GE}}=0\text{V}, T_J=25^\circ\text{C}$	---	---	0.01	mA
		$V_{\text{CE}}=600\text{V}, V_{\text{GE}}=0\text{V}, T_J=150^\circ\text{C}$	---	---	1	mA
Gate to Emitter Leakage Current	I_{GES}	$V_{\text{GE}}=\pm 30\text{V}, V_{\text{CE}}=0\text{V}$	---	---	± 250	nA
Total Gate Charge	Q_g	$V_{\text{CC}}=480\text{V}, V_{\text{GE}}=15\text{V}, I_C=30\text{A}$	---	122	---	nC
Gate to Emitter Charge	Q_{ge}		---	31	---	nC
Gate to Collector Charge	Q_{gc}		---	54	---	nC
Turn-On Delay Time	$t_{\text{d}(\text{ON})}$	$V_{\text{CE}}=400\text{V}, V_{\text{GE}}=0/15\text{V}, R_G=5\Omega, I_C=30\text{A}, T_J=25^\circ\text{C}$ Inductive Load	---	20	---	ns
Rise Time	t_r		---	16	---	
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		---	160	---	
Fall Time	t_f		---	15	---	
Turn-On Switching Loss	E_{on}		---	0.35	---	mJ
Turn-Off Switching Loss	E_{off}		---	0.32	---	
Total Switching Loss	E_{ts}		---	0.67	---	
Input Capacitance	C_{ies}	$V_{\text{CE}}=25\text{V}, V_{\text{GE}}=0\text{V}, f=1\text{MHz}$	---	3450	---	pF
Output Capacitance	C_{oes}		---	92	---	
Reverse Transfer Capacitance	C_{res}		---	55	---	

Drain-Source Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Diode Forward Voltage	V_F	$V_{\text{GE}}=0\text{V}, I_F=30\text{A}, T_J=25^\circ\text{C}$	---	1.7	---	V
Reverse Recovery Time	t_{rr}	$I_F=30\text{A}, dI/dt=200\text{A}/\mu\text{s}, T_J=25^\circ\text{C}$	---	170	---	nS
Reverse Recovery Charge	Q_{rr}		---	0.5	---	uC
Diode Peak Reverse Recovery Current	I_{rrm}		---	4.2	---	A

Note:

1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$

600V/30A Field Stop Trench IGBT

Typical Characteristics

Figure 1 Output Characteristics

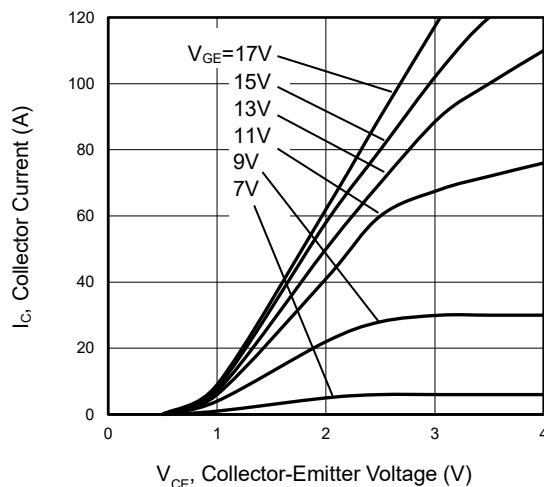


Figure 2 Transfer Characteristics

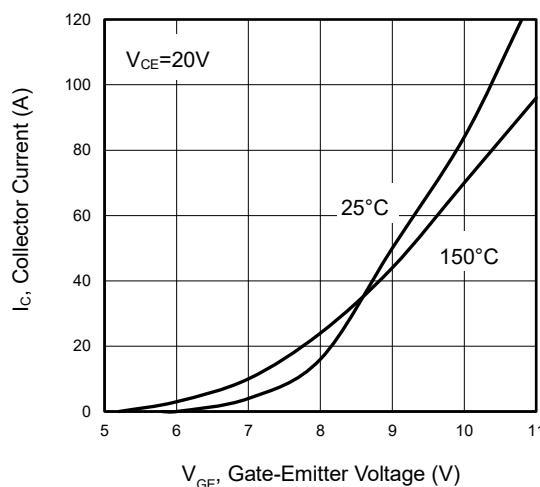


Figure 3 V_{CEsat} vs. Case Temperature

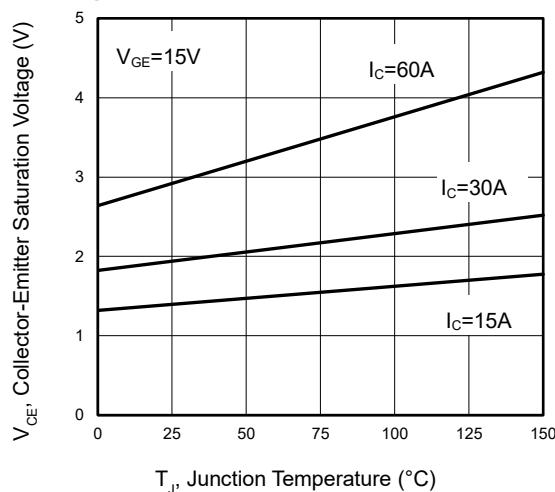


Figure 4 Saturation Voltage vs. V_{GE}

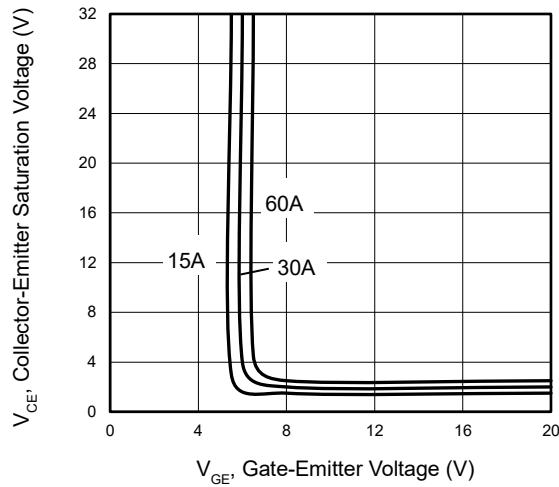


Figure 5 Capacitance Characteristics

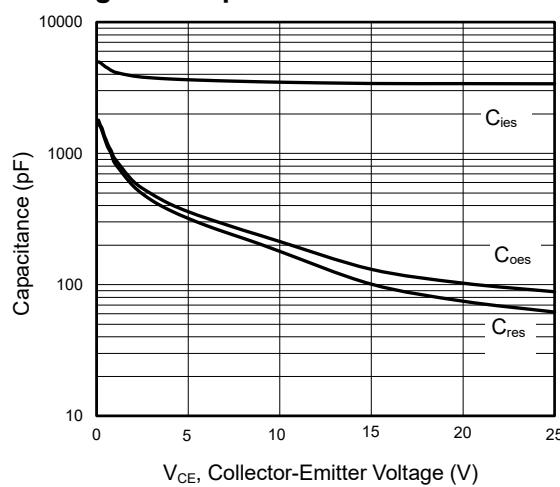
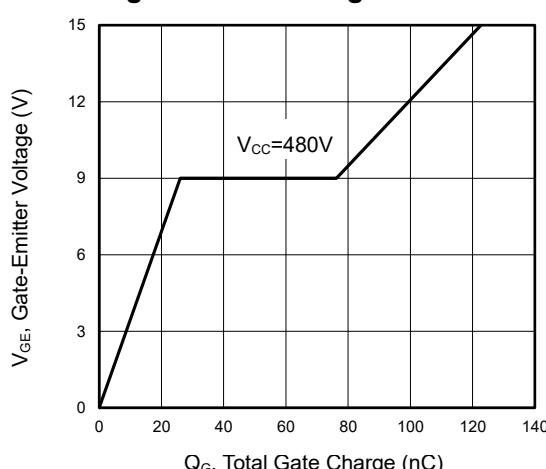


Figure 6 Gate charge waveform



600V/30A Field Stop Trench IGBT

Figure 7 Gate-emitter Threshold Voltage as a Function of Junction Temperature

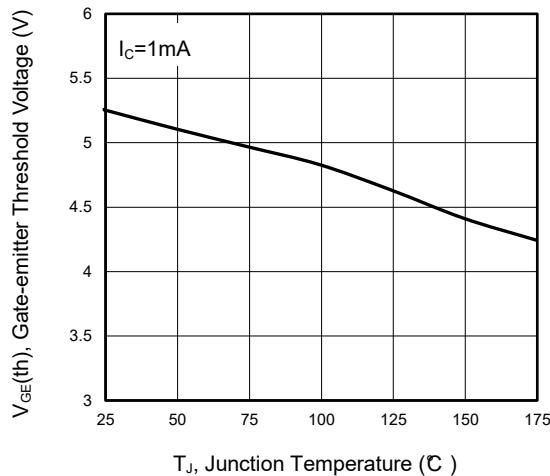


Figure 8 Power Dissipation as a Function of Case Temperature

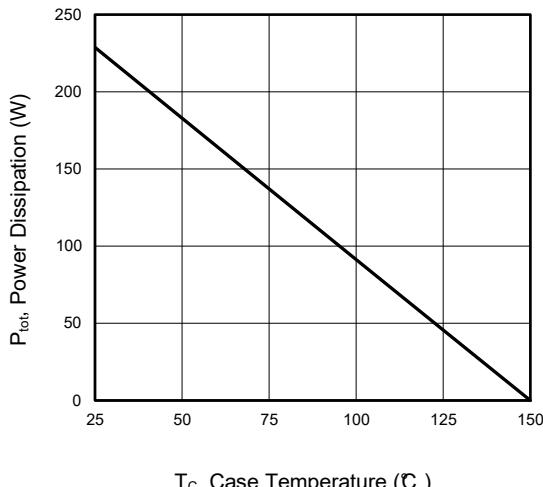


Figure 9 Typical Switching Times as a Function of Gate Resistor

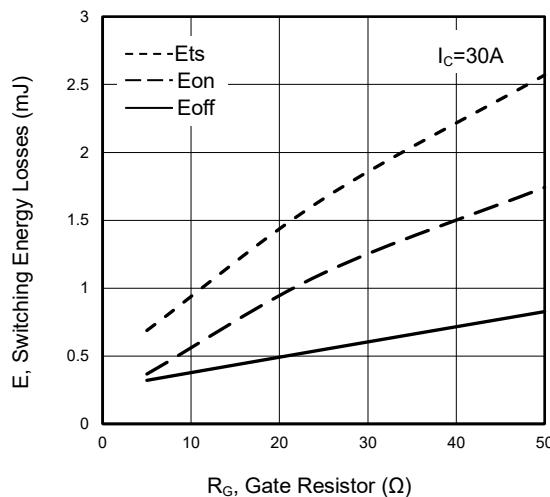


Figure 10 Typical Switching Times as a Function of Junction Temperature

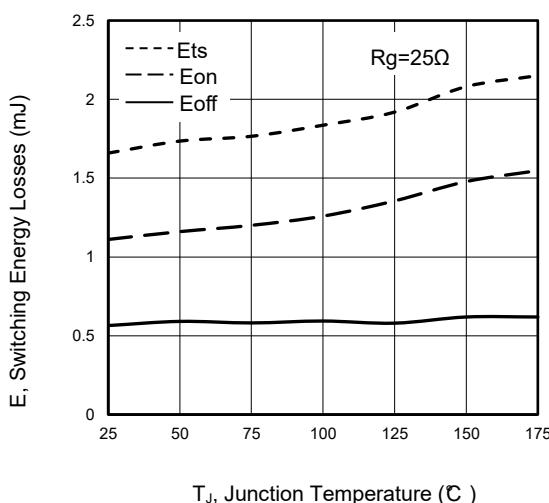


Figure 11 Typical Collector-emitter Saturation Voltage as a function of Collector Current

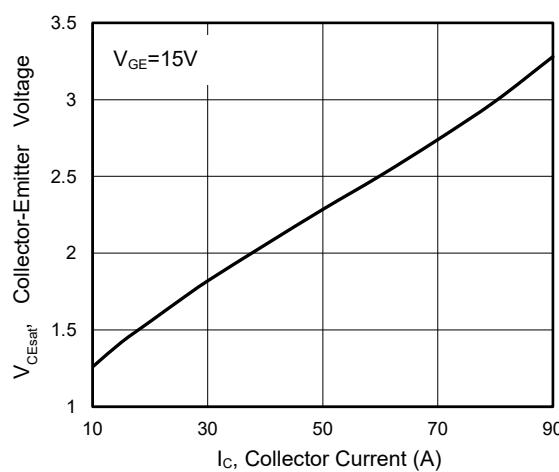
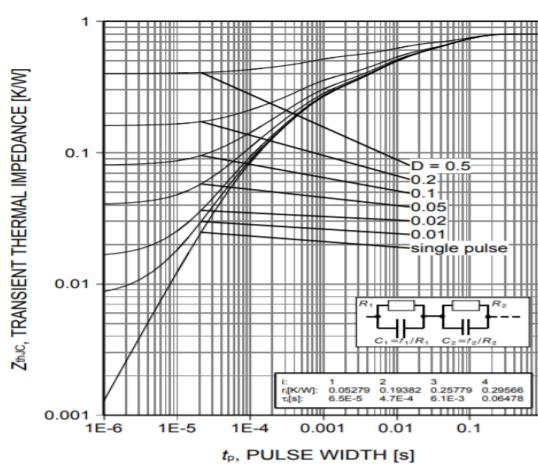
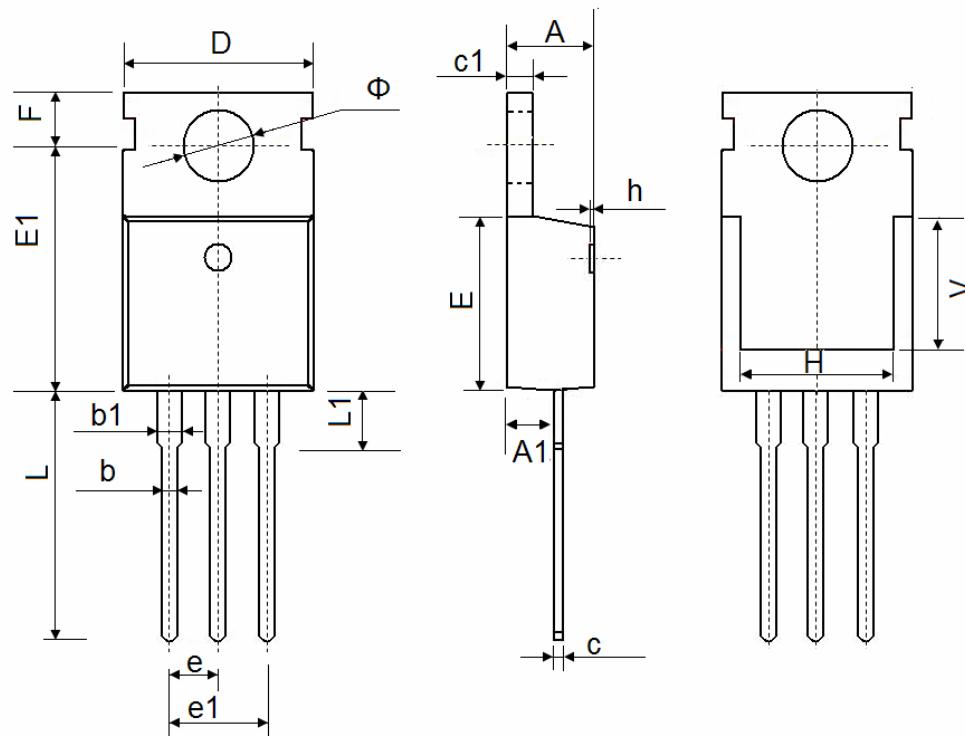


Figure 12 Transient Thermal Impedance



600V/30A Field Stop Trench IGBT
TO-220 Package Outline Data


Symbol	Dimensions In Millimeters	
	Min.	Max.
A	4.350	4.650
A1	2.250	2.550
b	0.710	0.910
b1	1.170	1.400
c	0.330	0.650
c1	1.200	1.400
D	9.910	10.250
E	8.9500	9.750
E1	12.650	12.950
e	2.540 TYP.	
e1	4.980	5.180
F	2.650	2.950
H	7.900	8.100
h	0.000	0.300
L	12.700	13.500
L1	2.850	3.250
V	7.500 REF.	
Φ	3.400	3.800